

Docket No.: 50090-306

UTILITY PATENT APPLICATION UNDER 37 CFR 1.53(b)



Box PATENT APPLICATION Commissioner for Patents Washington, DC 20231 Sir:

Transmitted herewith for filing is the patent application of:

INVENTOR: Hiroshi TOBIMATSU, Yuuki KAMIURA, Seiji OKURA, Mahito

SAWADA

FOR: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE HAVING

PASSIVATION FILM AND BUFFER COATING FILM

\boxtimes	10 pages of specification, claims, abstract.						
	Declaration and Power of Attorney.						
\boxtimes	Priority Claimed.						
\boxtimes	Certified copy of Japanese Patent Application No. 2001-000408						
\boxtimes .	3 sheets of formal drawing.						
$\boxtimes \checkmark$	An assignment of the invention to Mitsubishi Denki Kabushiki Kaisha and Ryoden						
	Semiconductor System Engineering Corporation						
	and the assignment recordation fee.						
	An associate power of attorney.						
	A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27.						
\boxtimes	Information Disclosure Statement, Form PTO-1449 and reference.						
\boxtimes	Return Receipt Postcard						

The filing fee has been calculated as shown below:

MANAGE TENES	NO. OF		EXTRA		
	CLAIMS		CLAIMS	RATE	AMOUNT
Total Claims	6	-20	0	\$18.00	\$0.00
Independent Claims	1	-3	0	\$80.00	\$0.00
Multiple Dependent Claim(s)					\$0.00
Basic Fee					
Total of Above Calculations \$710.00					
Less ½ for Small Entity \$0.00					
Assignment & Recording Fee \$40.					
				il Total Fee	\$750.00



\boxtimes	Please charge my Deposit Account No.	500417 in the amount of \$750.00.	A duplicate
	copy of this sheet is enclosed.		

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 500417. A duplicate copy is enclosed.

Any additional filing fees required under 37 CFR 1.16.

The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 500417. A duplicate copy of this sheet is enclosed.

Any patent application processing fees under 37 CFR 1.17.

Any filing fees under 37 CFR 1.16 for presentation of extra claims.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

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Date: July 24, 2001

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